

METHODS FOR PREPARING A SKIN GRAFT

Related Application

The present applications claims the benefit of and priority to U.S. nonprovisional
5 application serial number 12/851,621, filed August 6, 2010, the content of which is incorporated
by reference herein in its entirety.

Field of the Invention

The present invention generally relates to methods for preparing a skin graft.

Background

Skin is the largest organ of the human body, representing approximately 16% of a
person's total body weight. Because it interfaces with the environment, skin has an important
function in body defense, acting as an anatomical barrier from pathogens and other
15 environmental substances. Skin also provides a semi-permeable barrier that prevents excessive
fluid loss while ensuring that essential nutrients are not washed out of the body. Other functions
of skin include insulation, temperature regulation, and sensation. Skin tissue may be subject to
many forms of damage, including burns, trauma, disease, and depigmentation (e.g., vitiligo).

Skin grafts are often used to repair such skin damage. Skin grafting is a surgical
20 procedure in which a section of skin is removed from one area of a person's body (autograft),
removed from another human source (allograft), or removed from another animal (xenograft),
and transplanted to a recipient site of a patient, such as a wound site. As with any surgical
procedure, skin grafting includes certain risks. Complications may include: graft failure;
rejection of the skin graft; infections at donor or recipient sites; or autograft donor sites oozing
25 fluid and blood as they heal. Certain of these complications (e.g., graft failure and rejection of
the skin graft) may be mitigated by using an autograft instead of an allograft or a xenograft.

A problem encountered when using an autograft is that skin is taken from another area of
a person's body to produce the graft, resulting in trauma and wound generation at the donor site.
Generally, the size of the graft matches the size of the recipient site, and thus a large recipient
30 site requires removal of a large section of skin from a donor site. As the size of the section of
skin removed from the donor site increases, so does the probability that the donor site will not

heal properly, requiring additional treatment and intervention. Additionally, as the size of the section of skin removed from the donor site increases, so does the possibility of infection. There is also increased healing time associated with removal of larger sections of skin because a larger wound is produced.

5 To address those problems, techniques have been developed that allow for expansion of a skin graft so that a harvested graft can treat a recipient site that is larger than a donor site. Such methods involve expanding a harvested graft on a substrate and applying the expanded substrate having the expanded graft to a recipient site. A problem associated with such techniques is that maintaining the substrate used for graft expansion in a stretched configuration results in stress on
10 the substrate that is not optimal, which stress negatively affects interaction of the graft and the recipient site. Additionally, the stretched substrate may not retain the same properties as the unstretched configuration of the substrate, i.e., technological characteristics, such as physical, environmental and performance characteristics could be affected by the stretching of the substrate.

15 There is an unmet need for skin grafting methods and apparatuses.

Summary

The present invention generally relates to methods for preparing a skin graft that involve transferring a graft from a stretched first substrate to at least one other substrate. By transferring
20 an expanded graft from a stretched first substrate to at least one other substrate, methods of the invention minimize manipulation and stress of the substrate that holds the graft to the recipient site, while still allowing for repair of a recipient site that is larger than a donor site from which the graft is obtained. In certain embodiments, methods of the invention involve harvesting a single graft or a plurality of skin grafts from a subject, applying the graft(s) to a first substrate,
25 stretching or expanding the first substrate, and transferring the graft(s) from the first substrate to at least one other substrate for application to a patient recipient site. Methods of the invention minimize trauma and wound generation at a donor site, provide treatment for a recipient site that is larger than a donor site, and minimize manipulation and stress of a medical dressing that holds a graft to a recipient site.

30 In certain embodiments, methods of the invention allow for preparing a skin graft for transfer to a recipient site without culturing the graft or applying biologics to the graft. Rather,

certain methods of the invention use mechanical techniques for preparation of a skin graft, e.g. air pressure to stretch the substrate, thereby expanding the grafts.

In certain embodiments, methods of the invention further include ensuring that the orientation of the skin grafts are maintained while transferring the grafts from the first substrate
5 to the second substrate. Orientation of the graft may affect graft rejection.

Harvesting of skin grafts can occur by any method known in the art. In certain embodiments, harvesting involves raising a plurality of blisters, and cutting the blisters to obtain a plurality of skin grafts. In certain embodiments, raising a plurality of blisters involves applying heat, vacuum pressure, or a combination thereof. In certain embodiments, the blister may be a
10 fluid-filled blister (e.g. a suction blister). In other embodiments, the blister is not fluid-filled, i.e., raised skin having only air within. Any type of raised blister (fluid-filled or not fluid-filled) may be used with methods of the invention.

Methods of the invention are used to prepare any type of skin graft, such as an epidermal skin graft, a split thickness graft, or a full thickness graft. In particular embodiments, methods of
15 the invention are used to prepare skin grafts including only or substantially only the epidermal layer of skin. Methods of the invention can be used for autografts, allografts, or xenografts. In preferred embodiments, the grafts are autografts.

In certain embodiments, methods of the invention involve transferring graft material from a first substrate to at least one additional substrate for application to a recipient site. In certain
20 embodiments, more than one transfer of the grafts is performed, such as at least two transfers, at least three transfers, at least four transfers, or at least five transfers. By transferring the micrografts from the stretched first substrate to at least one other substrate, there is minimization of manipulation and stress of the substrate that holds the graft to the recipient site. The substrates can be the same, or different materials. In certain embodiments, the substrates are
25 medical dressings. In other embodiments, at least one of the substrates includes a biological or chemical substance, such as an antibiotic or growth factor.

Methods of the invention are used to prepare skin grafts for any recipient site of damaged skin. Exemplary types of skin damage include burns (e.g., thermal or chemical), infections, wounds, or depigmentation. In particular embodiments, the recipient site is an area of
30 depigmented skin that has been prepared to receive a skin graft.

Brief Description of the Drawings

Figure 1 is a drawing showing the anatomy of skin.

Figure 2 panels A-C are schematics showing a device for generating and harvesting a plurality of micrografts. Panel A provides an exploded view of the device. Panel B provides a top view of the assembled device. Panel C provides a side view of the assembled device.

Figure 3 provides a schematic of an exemplary process for preparing a skin graft according to methods of the invention. Panel A shows an excised epidermal blister sitting on a sterile cutting surface with a sterile cutter tool above. Panel B shows the cutter tool cutting the epidermal blister to generate an array of micrografts. Panel C shows the array of micrografts that has been produced by the cutting tool sitting on a first substrate. Panel D shows the first substrate placed into an expansion device. A second substrate is placed into the assembly cap above. Panel E shows the expansion process. As the first substrate expands, the micrografts move apart. Panel F shows that as the first substrate flattens against the assembly cap, the micrografts are transferred to the second substrate. Panel G shows the completed expansion process and that the micrografts have been transferred to the second substrate. Panel H shows removal of the assembly cap having the second substrate and expanded micrografts from the expansion device. Panel I shows removal of the second substrate having the expanded micrografts from the assembly cap of the expansion device.

Figure 4 panels A-B are drawings showing a device of the invention for raising a suction blister.

Figure 5 panels A-D show different devices of the invention for raising a suction blister.

Figure 6 is a process chart showing steps for treating vitiligo using methods of the invention.

Detailed Description

The skin consists of 2 layers. The outer layer, or epidermis, is derived from ectoderm, and the thicker inner layer, or dermis, is derived from mesoderm. The epidermis constitutes about 5% of the skin, and the remaining 95% is dermis. Figure 1 provides a diagram showing the anatomy of skin. The skin varies in thickness depending on anatomic location, gender, and age of the individual. The epidermis, the more external of the two layers, is a stratified squamous epithelium consisting primarily of melanocytes and keratinocytes in progressive stages

of differentiation from deeper to more superficial layers. The epidermis has no blood vessels; thus, it must receive nutrients by diffusion from the underlying dermis through the basement membrane, which separates the 2 layers.

The dermis is a more complex structure. It is composed of 2 layers, the more superficial papillary dermis and the deeper reticular dermis. The papillary dermis is thinner, including loose connective tissue that contains capillaries, elastic fibers, reticular fibers, and some collagen. The reticular dermis includes a thicker layer of dense connective tissue containing larger blood vessels, closely interlaced elastic fibers, and coarse, branching collagen fibers arranged in layers parallel to the surface. The reticular layer also contains fibroblasts, mast cells, nerve endings, lymphatics, and some epidermal appendages. Surrounding the components of the dermis is the gel-like ground substance composed of mucopolysaccharides (primarily hyaluronic acid), chondroitin sulfates, and glycoproteins.

In a graft, the characteristics of the donor site are more likely to be maintained after grafting to a recipient site as a function of the thickness of the dermal component of the graft. However, thicker grafts require more favorable conditions for survival due to the requirement for increased revascularization. It has been discovered, however, that a substantially epidermal graft according to the invention is more likely to adapt to the characteristics of the recipient site.

The present invention provides methods and devices for preparing and using skin grafts. In certain embodiments, the invention relates to preparing a skin graft for transfer to a recipient site without culturing the graft or applying biologics to the graft.

In certain embodiments, methods of the invention involve harvesting a plurality of skin grafts from a subject, applying the grafts to a first substrate, stretching the first substrate, and transferring the grafts from the first substrate to a second substrate for application to a patient recipient site.

Harvesting of the skin grafts may be accomplished by any technique known in the art, and the technique employed will depend on the type of graft required (e.g., epidermal graft, split thickness graft, or full thickness graft). An epidermal graft refers to a graft that consists of substantially epidermal skin and does not include any substantial portion of the dermal layer. A split thickness graft refers to a graft that includes sheets of superficial (epithelial) and some deep layers (dermal) of skin. A full-thickness graft refers to a graft that includes all of the layers of the skin including blood vessels.

In certain embodiments, a device as shown in Figure 2 panels A-C is used to obtain the plurality of skin grafts. Device **200** includes a frame **201** and a lid **202**. Fitted into the frame is a bottom plate **203**, a cutter grid plate **204**, a cutter plate **205**, and a top plate **206**. The bottom plate **203**, the cutter plate **205**, and the top plate **206**, each include a hole array **211**. Once
5 assembled, the hole array **211** of each of plates **203**, **205**, and **206** are aligned. The size of the holes in the hole array will depend on the size of the graft needed, with larger holes being used to produce larger grafts. A first substrate **207** interacts with the top plate **206** and will receive the harvested grafts.

Device **200** further includes an actuation block **208**, actuation bar **209**, and actuation
10 block guides **210**. Actuation components **208**, **209**, and **210** control movement of the cutter plate **205**. The frame **201** includes a vacuum stop **212** and the lid **202** includes a suction hole barb **213**. Once assembled, the frame **201** and lid **202** are arranged such that the vacuum stop **212** and the suction hole barb **213** are aligned with each other (Figure 1 panel B). A vacuum source is then connected to the device **200** such that negative pressure can be generated within the device.
15 The device **200** can be held together by clamp screws **214**. Device **200** may also include a heating element.

To produce and harvest the plurality of skin grafts, device **200** is placed on a donor site, such as an inner thigh of a patient. The vacuum source is turned on, producing negative pressure within device **200**. The negative pressure causes the skin to be pulled toward lid **202**, with a
20 plurality of different portions of skin being pulled through each hole array **211** in each of plates **203**, **205**, and **206**. Such action results in generation of many microblisters. The blisters may or may not be fluid-filled. Any type of raised blister may be used with methods of the invention.

Once the microblisters are raised, actuation components **208**, **209**, and **210** are engaged to move cutter plate **205**. The movement of cutter plate **205** disrupts the alignment of the hole
25 arrays **211** in each of plates **203**, **205**, and **206**, and results in cutting of the microblisters. The cut microblisters are captured on the first substrate **207** that is above top plate **206**. In this manner, there is provided a spaced apart array of micrografts. The amount of negative pressure applied, the amount of time the vacuum is maintained, and/or the depth of the holes above the cutting surface (plate **206**) determines what type of graft will be harvested, e.g., epidermal graft,
30 split thickness graft, or full thickness graft. Generally, each micrograft will have a lateral dimension of less than about 2 mm e.g., 100 to 2000 microns.

Once the grafts have been harvested and applied to the first substrate, the first substrate is stretched or expanded, resulting in increased distance between the individual micrografts, moving them apart and resulting in production of a skin graft that can repair a recipient site that is larger than the donor site from which the grafts were obtained. In methods of the invention, the individual grafts themselves are not expanded, i.e., the graft tissue is not stretched; rather, stretching of the substrate increases the space or distance between each individual micrograft. Methods of the invention thus minimize tissue manipulation.

The purpose of such processing is to use tissue from a donor site to cover a wound area that is larger than the donor site. The stretching of the substrate may be done manually, i.e., by hand, or may be done with the help of a machine. The stretching may be substantially uniform in all directions or may be biased in a certain direction. In a particular embodiment, the stretching is substantially uniform in all directions. Stretching of the substrate may be performed mechanically or may be accomplished by application of a pressurized fluid or gas. In certain embodiments, air pressure is used to expand the first substrate. Exemplary devices and methods are described in Korman (U.S. 5,914,264), the content of which is incorporated by reference herein in its entirety.

Any minimum distance can be provided between micrografts after the first substrate is stretched. The amount of stretching can be large enough to provide a sufficiently large area of substrate containing micrografts to allow a larger area of damaged tissue to be repaired using a particular amount of graft tissue removed from the donor site, i.e., the area of the stretched first substrate containing the separated micrografts can be much larger than the total area of the donor site. For example, the distance between adjacent micrografts on the stretched first substrate can be greater than about 0.5 mm, although small separation distances may also be used. For repigmentation of skin tissue, an amount of stretching can be applied to the first substrate such that the distance between adjacent micrografts is less than about 4 mm, because it is known that melanocytes, when grafted to a depigmented region, can migrate up to about 2 mm from each micrograft to repigment regions between the micrografts. This average distance can be larger if keratinocyte migration is involved with the tissue being treated because keratinocytes typically migrate greater distances compared to melanocytes.

The ratio of the wound area to the donor site area is referred to as the expansion ratio. A higher expansion ratio is desirable to minimize the trauma of the donor site, and to aid patients

who have only a small amount of tissue available for grafting purposes. The amount of area expansion, e.g., the ratio of an area of damaged tissue that can be repaired compared to an area of graft tissue removed from a donor site, may be 500x or more. In particular embodiments, the area of expansion may be from about 10x to about 100x, which provides a more uniform coverage and/or repigmentation of the recipient site. For repairing burns or ulcerated tissue, the micrografts may be smaller than those used to repair other types of damaged tissue, and thus the distances between adjacent micrografts may be greater after stretching of the first substrate. In such an exemplary application, an area expansion of about 1000x or more may be used.

In other embodiments and depending on the material of the first substrate, maintaining the first substrate in a stretched configuration may result in stress on the substrate that is not optimal. Additionally, the stretched first substrate may not retain the same properties as the unstretched configuration of the first substrate, i.e., technological characteristics, such as physical, environmental and performance characteristics could be affected by the stretching of the substrate. Additionally, methods used to maintain the substrate in its stretched condition may be physically cumbersome and prevent uniform application of the micrografts to uneven skin surfaces. Thus in certain embodiments, once the first substrate has been stretched, the spaced apart micrografts are transferred to a second substrate. By transferring the micrografts to a second substrate, methods of the invention minimize manipulation and stress of the substrate that holds the graft to the recipient site.

After stretching the first substrate, the second substrate is brought into contact with the grafts on the stretched first substrate. Transfer is facilitated by the second substrate having greater affinity or more adhesive force toward the micrografts than the first substrate. In certain embodiments, the second substrate is coated with a hydrocolloid gel. In other embodiments, the first substrate is wetted with a fluid such as water or a saline solution. Wetting the micrografts and the first substrate provides lubrication between the grafts and the first substrate and allows for easy transfer of the grafts from the first substrate to the second substrate. After wetting the first substrate, the grafts have greater affinity for the second substrate than the first substrate. The wetted first substrate is then removed from the second substrate and the grafts remain attached to the second substrate. The distance between the micrografts is maintained after transfer of the micrografts from the stretched first substrate to the second substrate.

The first substrate may be made from any material that is biocompatible and capable of being stretched upon application of a moderate tensile force. The second substrate may be made from any material known in the art that is compatible with biological tissue. The second substrate may also be capable of being stretched upon application of a moderate tensile force.

5 Exemplary materials for the first and/or second substrates include medical dressings, such as TEGADERM (medical dressing, commercially available from 3M, St. Paul, MN) or DUODERM (medical dressing, commercially available from 3M, St. Paul, MN). The first and/or second substrates may also be gas permeable.

10 In certain embodiments, the first and/or second substrates include an adhesive on one side that facilitates attachment of the grafts to the substrates. The substrate material may have intrinsic adhesive properties, or alternatively, a side of the substrate may be treated with an adhesive material, e.g., an adhesive spray such as LEUKOSPRAY (Beiersdoerf GmbH, Germany). In certain embodiments, the first and second substrates are the same material. In other embodiments, the first and second substrates are different materials. In certain
15 embodiments, the materials of the first and second substrates are chosen to facilitate transfer of the micrografts from the first substrate to the second substrate. For example, in certain embodiments, the material chosen for the first substrate has a weaker adhesive than the material chosen for the second substrate.

In certain embodiments, the material of the first substrate is a deformable non-resilient
20 material. A deformable non-resilient material refers to a material that may be manipulated, e.g., stretched or expanded, from a first configuration to a second configuration, and once in the second configuration, there is no residual stress on the substrate. Such materials may be stretched to an expanded configuration without returning to their original size, and thus in these embodiments it is not necessary to transfer the micrografts from a first substrate to a second
25 substrate. Instead, the expanded first substrate including the micrografts is applied to a recipient site.

Such deformable non-resilient materials tend to be soft, stiff or both soft and stiff. Softness is measured on the durometer scale. An example of such a material is a soft polyurethane. A soft polyurethane is produced is as follows. Polyurethanes in general usually
30 have soft and hard segments. The hard segments are due to the presence of phenyl bridges. In a soft polyurethane, the phenyl bridge is switched out for an aliphatic, which is more flexible as its

6 carbon ring has no double bonds. Therefore, all the segments are soft. On the Durometer Scale, a soft polyethylene is rated about Shore 80A. Other materials suitable for use with methods of the invention include low density polyethylene, linear low density polyethylene, polyester copolymers, polyamide copolymers, and certain silicones. In these embodiments, the expanded first substrate having the micrografts retains its expanded position without any residual stress, and the expanded first substrate is applied to a recipient site.

Ultimately, the grafts and substrate are applied to a recipient of site of a patient. Prior to applying the grafts to the recipient site, the site is prepared to receive the grafts using any technique known in the art. Necrotic, fibrotic or avascular tissue should be removed. The technique used to prepare the site will depend on damage to the recipient site. For example, epidermal tissue, if present at the recipient site, can be removed to prepare the area for receiving the micrografts. Burned or ulcerated sites may not need removal of epidermal tissue, although some cleaning of the site or other preparation of the site may be performed. Wounds should be debrided and then allowed to granulate for several days prior to applying the graft. Most of the granulation tissue should be removed since it has a tendency to harbor bacteria. Applying silver sulfadiazine to the wound for 10 days prior to grafting reduces the bacterial count greatly.

The size of the area at the recipient site can be about the same size as the area of the stretched first substrate having micrografts adhered thereto. This size generally will be greater than the area of the original graft tissue that was removed from the donor site to form the micrografts. The depigmented or damaged skin can be dermabraded with sandpaper or another rough material. Alternatively, the epidermal tissue can be removed from the recipient site by forming one or more blisters over the area to be treated, e.g., a suction blister or a freezing blister, and the raised epidermal blister tissue can then be removed by cutting or another procedure.

The substrate having the micrografts can be placed over the area to be treated to form a dressing. A portion of the substrate having the micrografts can be positioned over the area to be repaired, e.g., the area from which the epidermal tissue has been abraded or removed for repigmentation. The substrate can be fixed in place over the treatment area, e.g., using tape or the like. The substrate can be removed after sufficient time has elapsed to allow attachment and growth of the micrografts in the treatment area, e.g., several days to a few weeks.

Another aspect of the invention provides harvesting a single graft from a donor site, such as an epidermal graft, generating an array of micrografts from the single graft, placing the graft on a first substrate, expanding a distance between the micrografts on a first substrate, transferring the micrografts from the first substrate to a second substrate, and applying the micrografts to a recipient site. Figure 3 provides a schematic of an exemplary process for preparing a skin graft according to methods of the invention.

Methods of the invention involve harvesting a single graft from a donor site, such as an epidermal graft. Harvesting of the skin grafts may be accomplished by any technique known in the art, and the technique employed will depend on the type of graft required (e.g., epidermal graft, split thickness graft, or full thickness graft). In certain embodiments, harvesting a skin graft involves raising a blister and cutting the blister. In certain embodiments, the blister may be a fluid-filled blister (e.g. a suction blister). In other embodiments, the blister is not fluid-filled. Any type of raised blister may be used with methods of the invention.

In certain embodiments, suction blister grafting is used. Suction blister grafting involves raising a blister, and then cutting off the raised blister. An exemplary suction blister grafting technique is shown in Awad, (Dermatol Surg, 34(9):1186-1193, 2008), the content of which is incorporated by reference herein in its entirety. This article also shows various devices used to form suction blisters. A suction blister device is also described in Kennedy et al. (U.S. 6,071,247), the content of which is incorporated by reference herein in its entirety. An exemplary device is commercially available from Electronic Diversities (Finksburg, MD).

A device for raising a suction blister typically operates by use of suction chambers that are attached to a patient's skin. An instrument typically contains a power source, a vacuum pump, temperature controls and all related controls to operate multiple suction chambers. The suction chambers are connected to the console by a flexible connection. Each of the chambers is controlled by a preset temperature control to provide an optimal skin warming temperature. Both chambers share an adjustable common vacuum source that affects all chambers equally.

Blister formation is accomplished by attaching the suction blister device to a patient's skin. Typically hook & loop fastener straps are used to keep the device in place. The chamber heating system provides a slight warming of an orifice plate of the device, which is in direct contact with the patient's skin surface. The application of a moderate negative pressure from

the instrument console, to the chamber interior, causes the patients skin to be gently drawn through the opening(s) in the orifice plate. The results are typical suction blisters, approximately the size of the opening(s) in the orifice plate. The skin and blister area is generally not damaged and patient discomfort is minimal.

5 The negative pressure chamber is fabricated of mostly plastic components, with two removable threaded caps. The upper cap is fitted with a clear viewing lens so that the actual blister formation can be observed. The opposite end of the chamber is fitted with a removable orifice plate that is placed on the patient's skin. Since this plate is simply threaded onto the chamber end, multiple plates with different opening patterns can be interchanged as desired.

10 The interior of the device is warmed and illuminated by an array of low voltage incandescent lamps. This lamp array is controlled from the instrument console temperature controller, cycling as needed, to maintain the set point temperature. The heat from these lamps is radiated and conducted to the orifice plate, which then warms the patient's skin. The chamber is connected to the console via a composite vacuum and low voltage electrical system. Quick
15 connections are used for the vacuum and electrical system to facilitate removal and storage.

 The Negative Pressure Instrument console is a self-contained fan cooled unit which is designed to operate on 120 VAC 60 Hz power. Vacuum is supplied by an industrial quality diaphragm type vacuum pump, capable of a typical vacuum of 20 in Hg (0-65 kpa) at 0 CFM. An analog controller that is preset to 40 °C provides the temperature control for each suction
20 chamber. This provides accurate control of the orifice plate temperature. The instrument console has internal adjustments that allow the user to recalibrate the temperature setting if desired. Other temperatures can be preset if desired. The front panel includes a vacuum gauge and vacuum bleeder adjustment to regulate the vacuum to both chambers. The console front panel also contains the connections for the chamber assemblies.

25 Once the suction blister is raised, it is cut by methods known in the art (see e.g., Awad, *Dermatol Surg*, 34(9):1186-1193, 2008), and placed on the first substrate. Once on the first substrate, an array of micrografts are generated from the single graft. Figure 3 panel A shows an excised skin graft on a first substrate, with a sterile cutting tool above the graft. In certain embodiments, rather than being applied directly to the first substrate, the cut blister is placed
30 onto a sterile surface, such as a glass slide, and the array of micrografts is generated on the sterile surface prior to transfer to the first substrate. In other embodiments, the cut blister is trapped

between two aligned metal screens. The screens are pushed together to cut the blister into an array of micrografts. The micrografts are then pushed out of the screens and deposited onto the first substrate using an array of pushers whose size and spacing correspond to the metal screens. In certain embodiments, the cut blister is harvested directly between the two screens for
5 generation of the array of micrografts.

In other embodiments, the cut blister is harvested directly into a shear or punch and die device for generation of micrografts. A shear or punch die includes an array of flat-faced piston-like components that fit closely into the openings in a metal screen/mesh. In this embodiment, the cut graft is harvested onto the array of pistons, and sits between the array of pistons and the
10 screen/mesh. The screen/mesh is closed over the cut blister and force is applied to the array of pistons. The pistons push through the holes in the screen/mesh and in the process, portions of tissue are punched out from the openings of the screen/mesh and deposited on a substrate, producing an array of micrografts on a substrate. Such embodiments allow for simultaneous generation of the array of micrografts and deposition of the array of micrografts onto the
15 substrate.

The array of micrografts can be generated by making cuts or using other protocols to form the array of micrografts from the single graft. The cuts may pass partially or completely through the graft tissue. For example, for repigmenting skin tissue, the micrografts used may have a presence of melanocytes. Accordingly, a lateral dimension of such micrografts can be
20 between less than about 1 mm, e.g., 200 to 1000 microns. Other exemplary sizes are between 400 and 800 microns. The area of the micrografts can be between about 0.04 mm^2 and about 1 mm^2 . The exemplary sizes can provide micrografts large enough such that each micrograft is likely to contain some melanocytes, yet small enough to provide a large number of micrografts from a particular piece of graft tissue, which can facilitate a significant degree of expansion on
25 the graft site.

For treating burns or ulcers, where presence and proliferation of keratinocytes is important, the micrograft sizes may be smaller. For example, a lateral dimension of micrografts containing keratinocytes can be between about 50 microns and about 1000 microns, or between 100 microns and about 800 microns. The area of such micrografts can be between about 0.0025
30 mm^2 and about 1 mm^2 . The exemplary size ranges provide micrografts large enough to contain

viable and undamaged keratinocytes, and small enough to facilitate repair of a larger area of damaged skin.

Figure 3 panel B shows an exemplary cutting tool. The cutting tool may be configured in any manner, and such configuration will depend upon the size of the micrografts to be produced and the desired array pattern. The cutting tool includes a plurality of adjacent blades. The arrangement of the blades will depend upon the desired pattern for the array of micrografts. The tool shown in Figure 3 panel B is configured to produce a square grid of micrografts (See Figure 3 panel C). The spacing of the blades in the cutting tool will depend on the desired size of the micrografts. For example, the blades may be spaced about 100 to 2000 microns apart, or about 500 to 1000 microns apart. The cutting tool is pressed at least once into the skin graft on the first substrate to produce the array of micrografts (See Figure 3 panels B and C).

Other exemplary devices for producing an array of micrografts include mesh devices. Such mesh devices include rigid, biocompatible material, such as stainless steel. The mesh includes a plurality of openings. The openings are sized to provide an array of micrografts of a desired size, such as lateral sizes between about 100 microns and about 1000 microns or about 300 microns to about 500 microns. Similar to the cutting tool described above, the mesh is pressed at least once into the skin graft to produce the array of micrografts.

Figure 3 panels D-I show remaining steps of the method. Once the array of micrografts are on the first substrate, the distance between the micrografts is expanded. Expansion results in increased distance between the individual micrografts, moving them apart and resulting in production of a skin graft that can repair a recipient site that is larger than the donor site from which the grafts were obtained. Expansion may be performed as described above. After expansion of the first substrate, the second substrate is brought into contact with the grafts on the stretched first substrate for transfer of the micrografts from the expanded first substrate to the second substrate. Transfer may be performed as described above. The distance between the micrografts is maintained after transfer of the micrografts from the stretched first substrate to the second substrate. Once the grafts have been transferred to the second substrate, the grafts and substrate are applied to a recipient of site of a patient. Preparation of the recipient site and application of the array of micrografts to the prepared recipient site may be performed as described above.

In other embodiments, transfer to a second substrate is not necessary because the material of the first substrate is a deformable non-resilient material. A deformable non-resilient material refers to a material that may be manipulated, e.g., stretched or expanded, from a first configuration to a second configuration, and once in the second configuration, there is no residual stress on the substrate. Such materials may be stretched to an expanded configuration without returning to their original size. Exemplary materials are described above. In these embodiments, the expanded first substrate having the micrografts retains its expanded position without any residual stress, and the expanded first substrate is applied to a recipient site. Preparation of the recipient site and application of the array of micrografts to the prepared recipient site may be performed as described above.

In certain aspects, methods of the invention maintain a proper orientation of a skin graft. Epidermal skin includes a stratum corneum layer and a basal layer. The stratum corneum refers to the outermost layer of the epidermis, composed of large, flat, polyhedral, plate-like envelopes filled with keratin, which is made up of dead cells that have migrated up from the stratum granulosum. This layer is composed mainly of dead cells that lack nuclei. The thickness of the stratum corneum varies according to the amount of protection and/or grip required by a region of the body. In general, the stratum corneum contains 15 to 20 layers of dead cells, and has a thickness between 10 and 40 μm .

The basal layer (or stratum germinativum or stratum basale) refers to the deepest layer of the 5 layers of the epidermis. The basal layer is a continuous layer of live cells and can be considered the stem cells of the epidermis. These cells are undifferentiated and proliferative, i.e., they create daughter cells that migrate superficially, differentiating during migration. Keratinocytes and melanocytes are found in the basal layer.

For a graft to become integrated at a recipient site, the graft must be able to receive nutrients. Since the cells of the basal layer are live cells, orienting an epidermal graft such that the basal layer interacts with the recipient site allows the graft to receive nutrients, and thus remain viable. In contrast, since the cells of the stratum corneum are dead cells, orienting an epidermal graft such that the stratum corneum layer interacts with the recipient site prevents the graft from receiving nutrients, resulting in death of the graft tissue and graft failure. Methods of the invention ensure that during the grafting process, the basal layer of a graft interacts with the recipient site of a patient, allowing for the graft to receive nutrients and thus remain viable.

Certain methods involve harvesting an epidermal skin graft, and applying the epidermal skin graft to a recipient site such that the basal layer of the skin graft makes direct contact with the recipient site. Harvesting may be accomplished by creating a blister, such as a suction blister. Suction blister grafting is described above.

5 In one embodiment, a vacuum is used to hold the stratum corneum side of the blister, which can be released when the blister is deposited onto the cutting surface. In other embodiments, after the blister has been raised and prior to cutting the blister, an adhesive side of a substrate is placed in contact with the stratum corneum layer of the raised blister. Upon cutting the blister, the stratum corneum layer of the graft becomes adhered to the substrate, and the basal
10 layer is orientated away from the substrate. Such a technique ensures that the basal layer of the graft is oriented away from the substrate and is thus available to interact with the recipient site of a patient.

Other methods of the invention involve harvesting a skin graft from a donor site, placing the skin graft on a first substrate such that basal cells of the graft make direct contact with the
15 first substrate, transferring the graft from the first substrate to a second substrate such that the basal cells do not directly contact the second substrate, and applying the second substrate to a recipient site. Harvesting may be accomplished by creating a blister, such as a suction blister. Suction blister grafting is described above. The blister is cut and the basal layer of the graft is contacted to an adhesive side of a first substrate. The basal layer of the graft becomes adhered to
20 the first substrate and the stratum corneum layer is orientated away from the first substrate, and is available for interaction with a second substrate.

An adhesive side of a second substrate is brought into contact with the stratum corneum layer of the graft that is adhered to the first substrate. Transfer to the second substrate is accomplished as described above. Briefly, in one embodiment, the first substrate is wetted with
25 a fluid such as water or a saline solution. Wetting the graft and the first substrate provides lubrication between the graft and the first substrate and allows for easy transfer of the graft from the first substrate to the second substrate. After wetting the first substrate, the graft has a greater affinity for the second substrate than the first substrate. The wetted first substrate is then removed from the second substrate and the grafts remain adhered to the second substrate.

30 Upon transfer, the stratum corneum layer of the graft becomes adhered to the second substrate, and the basal layer is orientated away from the second substrate. Such a technique

ensures that the basal layer of the graft is oriented away from the second substrate and is thus available to interact with the recipient site of a patient.

Another aspect of the invention provides a devices for obtaining a skin graft. Devices of the invention include a hollow body having a distal end configured for placement on skin, a
5 mechanism for raising a blister, and a cutter integrated in the body for cutting the blister produced on the skin.

In certain embodiments, a device as shown in Figure 4 panel A is used to obtain a skin graft. Device **400** includes a hollow body **401** and a mechanism for raising a blister **402**. Hollow body **401** includes a distal end **403** that is configured for placement on the skin. Such a
10 distal end may include an orifice plate **404**. Orifice plate **404** determines the size and the shape of the blister or blisters that will be raised. Orifice plate **404** may be any shape or size and will depend on the blister or blisters to be raised. Generally, the diameter or lateral dimension of the blister may be from about 6 mm to about 12 mm, although larger or smaller blister sizes may be used.

15 The mechanism for raising a blister may be a vacuum component, a heating component, or a combination thereof. An exemplary heating component is a light source. In a particular embodiment, mechanism **402** is a combination of a vacuum component and a heating component.

The hollow body **401** further includes a cutter **405**, which includes cutter plate **406** and a
20 hole **407** (Figure 4 panel B). Device **400** further includes an actuation block **408**, actuation bar **409**, and actuation block guides **410**. Actuation components **408**, **409**, and **410** control movement of the cutter **405**.

Blister formation is accomplished by attaching the distal end **403** of hollow body **401** to donor site of a patient, such as an inner thigh of a patient. Hook and loop fastener straps may be
25 used to keep the device in place. The heating component of blister raising mechanism **402** provides a slight warming of orifice plate **404**, which is in direct contact with the patient's skin surface. The application of a moderate negative pressure to the chamber interior from the vacuum component of blister raising mechanism **402**, results in the patient's skin being gently drawn through the opening in orifice plate **404**. The result is a blister or blisters, approximately
30 the size of the opening in orifice plate **404**. The produced blister may be fluid-filled or may not

contain any fluid, i.e., a blister having air within. The skin and blister area is generally not damaged and patient discomfort is minimal.

The cutter **405** is positioned in hollow body **401** such that upon raising the blister, at least a portion of the blister protrudes through hole **407** in cutter plate **406**. The actuation components **408**, **409**, and **410** are engaged to move cutter plate **406**. The movement of cutter plate **406** disrupts the alignment of hole **407** with the other components of device **400**, and results in cutting of the raised blister.

Figure 5 panel A shows a device **500** that further includes a chamber **511** for capturing the cut blister. Chamber **511** is positioned in hollow body **501** and above cutter **505**. Chamber **511** may be removable from device **500**. Chamber **511** may include multiple configurations. For example, chamber **511** may include a retractable bottom. The bottom is in an open position when chamber **511** is inserted into hollow body **501**. In the open position, chamber **511** is able to receive the cut blister. Once the cut blister is in chamber **511**, the bottom of the chamber is closed, capturing the blister in chamber **511**. Chamber **511** may then be removed from device **500**.

In another embodiment, chamber **511** includes a substrate **512** (Figure 5 panel C). In this embodiment, device **500** is configured such that substrate **512** is positioned in chamber **511** so that upon raising the blister, a portion of the blister contacts the substrate and becomes attached to the substrate. Cutter **505** then cuts the blister, and the cut blister becomes attached to the substrate **512** in chamber **511**. Chamber **511** is then removed from device **500**, and substrate **512** may be removed from chamber **511**. In other devices, a vacuum, instead of a substrate, is used to hold the cut blister within the chamber.

In certain embodiments, device **500** does not use a chamber, rather a substrate **512** is directly integrated with device **500** in order to capture the cut blister (Figure 5, panel D). Once captured, substrate **512** having an attached cut blister may be removed from device **500**.

Methods of the invention may be used to prepare a skin graft to repair numerous different types of skin damage. For example, methods of the invention may be used to prepare grafts to treat burns (e.g., both thermal and chemical burns), blistering, dermatological conditions (e.g., epidermolysis bullosa or pyoderma gangrenosum), radiation therapy ulcers, diabetic ulcers, ischemic ulcers, trophic ulcers, trauma, or depigmentation (e.g., vitiligo).

In particular embodiments, methods of the invention are used to prepare a skin graft(s) to treat vitiligo. Vitiligo is a chronic disorder that causes depigmentation of patches of skin. It occurs when melanocytes, the cells responsible for skin pigmentation, die or are unable to function. Although patches are initially small, they often enlarge and change shape. When skin lesions occur, they are most prominent on the face, hands and wrists. Some lesions have hyper-pigmentation around the edges. Depigmentation is particularly noticeable around body orifices, such as the mouth, eyes, nostrils, genitalia and umbilicus.

Vitiligo is generally classified into two categories, non-segmental vitiligo and Segmental vitiligo. In non-segmental vitiligo (NSV), there is usually some form of symmetry in the location of the patches of depigmentation. New patches also appear over time and can be generalized over large portions of the body or localized to a particular area. Vitiligo where little pigmented skin remains is referred to as *vitiligo universalis*. Non-segmental vitiligo can come about at any age, unlike segmental vitiligo which is far more prevalent in teenage years.

Segmental vitiligo (SV) differs in appearance, aetiology and prevalence from associated illnesses. Its treatment is different from that of non-segmental vitiligo. It tends to affect areas of skin that are associated with dorsal roots from the spine. It spreads much more rapidly than non-segmental vitiligo and, without treatment, it is much more stable/static in course and not associated with auto-immune diseases.

Figure 6 is a process chart showing steps for treating vitiligo using methods of the invention. To treat vitiligo, an autograft is provided to the site of depigmented skin. The graft includes melanocytes, and thus upon the recipient site accepting the graft, the graft will produce pigmented skin at the recipient site. As shown in figure 6, a donor site of pigmented skin is aseptically cleaned prior to harvesting of a skin graft. Standard methods are used to clean the donor site. A typical donor site is an inner thigh, but any area of pigmented skin may be used.

After cleaning, a skin grafted is harvested by raising a blister, such as a suction blister, and cutting the blister. Devices described herein may be used to raise and cut the blister. Alternatively, commercially available blister devices may be used. Once cut, the epidermal blister is placed onto a sterile cutting apparatus and divided into an array of micrografts. The micrografts are transferred to a first substrate for expansion. Transfer may occur as described above. In certain embodiments, the cut blister is placed directly onto the first substrate and the array of micrografts are generated directly on the first substrate. The micrografts are expanded

What is claimed is:

1. A method for preparing a skin graft, the method comprising the steps of:
providing a device comprising a frame, a lid, a bottom plate, a cutter plate, and a top plate,
wherein said cutter plate is disposed between said top and bottom plates and wherein
said bottom, cutter and top plates are fitted in the frame and wherein each plate
comprises a plurality of holes and wherein as assembled the holes in the plates are
aligned and the cutter plate is movable within the frame, and wherein the lid is adapted
for connecting with a vacuum source;
contacting the device to skin;
applying a vacuum to generate a negative pressure within the device to thereby raise a
plurality of blisters through the aligned holes;
actuating the cutter plate to disrupt the alignment of the holes and to cut the raised blisters,
thereby generating a plurality of skin grafts; and
applying said grafts to a substrate.
2. The method according to claim 1, wherein the skin graft is selected from the group consisting
of: an epidermal skin graft, a split thickness graft, and a full thickness graft.
3. The method according to claim 1, wherein the grafts are autografts.
4. The method according to claim 1, wherein the substrate comprises a medical dressing.
5. The method according to claim 1, further comprising transferring said grafts from said
substrate to at least another substrate prior to applying said grafts to a patient recipient site.
6. The method according to claim 5, wherein the substrates are formed of any of the same or
different materials.
7. The method according to claim 5, wherein orientation of the skin grafts are maintained while
transferring said grafts from said substrate to said another substrate.
8. The method according to claim 1, further comprising transferring said grafts from said
substrate to a patient recipient site, wherein the recipient site is an area of depigmented skin
that has been prepared to receive a skin graft.

9. The method according to claim 1, wherein the device further comprises an actuation block for controlling movement of the cutter plate.
10. The method according to claim 1, wherein said substrate is positioned above the top plate.
11. A method for preparing a skin graft, the method comprising the steps of:
providing a device comprising a frame, a lid, a bottom plate, a cutter plate, and a top plate,
wherein each plate comprises a plurality of holes and wherein the cutter plate is
movable within the frame, and wherein the frame includes a vacuum stop and the lid
includes a suction hole barb;
contacting the device to skin;
applying vacuum pressure to thereby raise a plurality of blisters;
actuating the cutter plate to cut the raised blisters, thereby generating a plurality of skin
grafts;
applying said grafts to a first substrate; and
transferring said grafts from said first substrate to at least a second substrate for
application to a patient recipient site.
12. The method according to claim 11, wherein the vacuum stop and the suction hole barb are
aligned with each other.
13. The method according to claim 11, wherein the skin graft is selected from the group
consisting of: an epidermal skin graft, a split thickness graft, and a full thickness graft.
14. The method according to claim 11, wherein the grafts are autografts.
15. The method according to claim 11, wherein the first and/or second substrates are medical
dressings.
16. The method according to claim 11, wherein the first and second substrates are the same
material.

17. The method according to claim 11, wherein the first and second substrates are different materials.

18. The method according to claim 11, wherein orientation of the skin grafts are maintained while transferring said grafts from said first substrate to said second substrate.

19. The method according to claim 11, wherein the recipient site is an area of depigmented skin that has been prepared to receive a skin graft.

20. The method according to claim 11, wherein the plurality of holes in each of the bottom plate, cutter plate, and top plate may be aligned with each other